

Silicon Diffused Power Transistor

BU2525DF

GENERAL DESCRIPTION

New generation, high-voltage, high-speed switching npn transistor with integrated damper diode in a plastic full-pack envelope intended for use in horizontal deflection circuits of large screen colour television receivers up to 32 kHz.

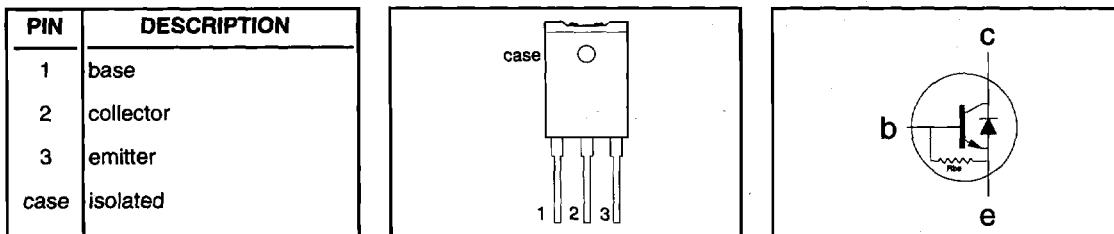
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0 \text{ V}$	-	1500	V
V_{CEO}	Collector-emitter voltage (open base)		-	800	V
I_c	Collector current (DC)		-	12	A
I_{CM}	Collector current peak value		-	30	A
P_{tot}	Total power dissipation	$T_{hs} \leq 25^\circ\text{C}$	-	45	W
V_{CEsat}	Collector-emitter saturation voltage	$I_c = 8.0 \text{ A}; I_B = 1.6 \text{ A}$	-	5.0	V
I_{Csat}	Collector saturation current		8.0	-	A
t_s	Storage time	$I_{Csat} = 8.0 \text{ A}; I_{B(end)} = 1.1 \text{ A}$	3.0	4.0	μs

PINNING - SOT199

PIN CONFIGURATION

SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0 \text{ V}$	-	1500	V
V_{CEO}	Collector-emitter voltage (open base)		-	800	V
I_c	Collector current (DC)		-	12	A
I_{CM}	Collector current peak value		-	30	A
I_B	Base current (DC)		-	8	A
I_{BM}	Base current peak value		-	12	A
$-I_{B(AV)}$	Reverse base current	average over any 20 ms period	-	200	mA
$-I_{BM}$	Reverse base current peak value ¹		-	9	A
P_{tot}	Total power dissipation	$T_{hs} \leq 25^\circ\text{C}$	-	45	W
T_{stg}	Storage temperature		-65	150	°C
T_j	Junction temperature		-	150	°C

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th,j-hs}$	Junction to heatsink	without heatsink compound	-	3.7	K/W
$R_{th,j-hs}$	Junction to heatsink	with heatsink compound	-	2.8	K/W
$R_{th,j-a}$	Junction to ambient	in free air	35	-	K/W

¹ Turn-off current.

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ISOLATION LIMITING VALUE & CHARACTERISTIC $T_{hs} = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{isol}	Repetitive peak voltage from all three terminals to external heatsink	R.H. $\leq 65\%$; clean and dustfree	-		2500	V
C_{isol}	Capacitance from T2 to external heatsink	$f = 1 \text{ MHz}$	-	22	-	pF

STATIC CHARACTERISTICS $T_{hs} = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CES}	Collector cut-off current ²	$V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax}$	-	-	1.0	mA
I_{CES}		$V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax}$	-	-	2.0	mA
I_{EBO}	Emitter cut-off current	$T_j = 125^\circ\text{C}$				
R_{eb}	Base-emitter resistance	$V_{EB} = 6.0 \text{ V}; I_c = 0 \text{ A}$	72	110	218	mA
BV_{EBO}	Emitter-base breakdown voltage	$V_{EB} = 6.0 \text{ V}$	-	55	-	Ω
$V_{CEO{sust}}$	Collector-emitter sustaining voltage	$I_B = 600 \text{ mA}$	7.5	13.5	-	V
V_{CEsat}	Collector-emitter saturation voltage	$I_B = 0 \text{ A}; I_c = 100 \text{ mA}$	800	-	-	V
V_{BESat}	Base-emitter saturation voltage	$L = 25 \text{ mH}$				
h_{FE}	DC current gain	$I_c = 8.0 \text{ A}; I_B = 1.6 \text{ A}$	-	-	5.0	V
h_{FE}		$I_c = 8.0 \text{ A}; I_B = 1.6 \text{ A}$	-	-	1.1	V
V_F	Diode forward voltage	$I_c = 1 \text{ A}; V_{CE} = 5 \text{ V}$	-	11	-	
		$I_c = 8 \text{ A}; V_{CE} = 5 \text{ V}$	5	7	9.5	
		$I_F = 8 \text{ A}$	-	1.6	2.0	V

DYNAMIC CHARACTERISTICS $T_{hs} = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
C_c	Collector capacitance	$I_E = 0 \text{ A}; V_{CB} = 10 \text{ V}; f = 1 \text{ MHz}$	145	-	pF
t_s	Switching times (32 kHz line deflection circuit)	$I_{Csat} = 8.0 \text{ A}; L_C = 260 \mu\text{H}; C_{fb} = 13 \text{ nF}; I_{B(end)} = 1.1 \text{ A}; L_B = 2.5 \mu\text{H}; -V_{BB} = 4 \text{ V}; (-dI_B/dt = 1.6 \text{ A}/\mu\text{s})$			
t_i	Turn-off storage time		3.0	4.0	μs
	Turn-off fall time		0.2	0.35	μs
V_{fr}	Anti-parallel diode forward recovery voltage	$I_F = 8 \text{ A}; dI_F/dt = 50 \text{ A}/\mu\text{s}$	16	-	V
t_{fr}	Anti-parallel diode forward recovery time	$V_F = 5 \text{ V}$	410	-	ns

² Measured with half sine-wave voltage (curve tracer).

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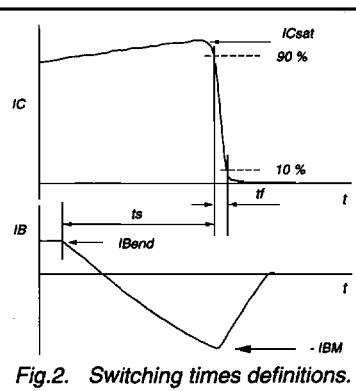
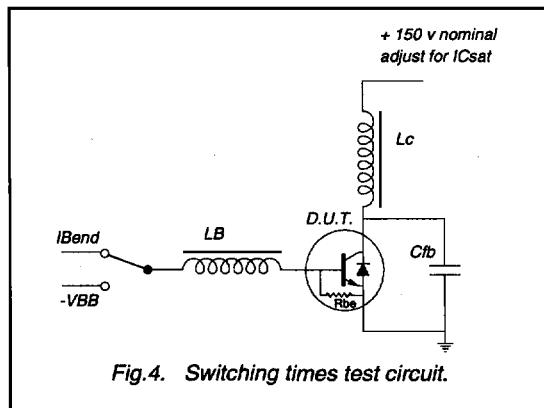
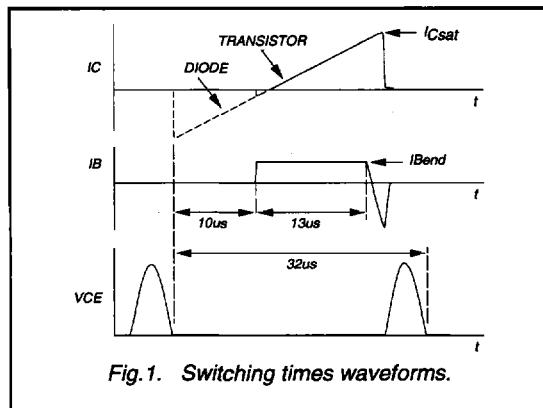
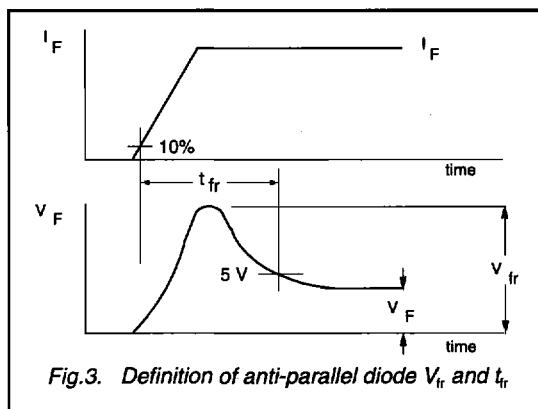
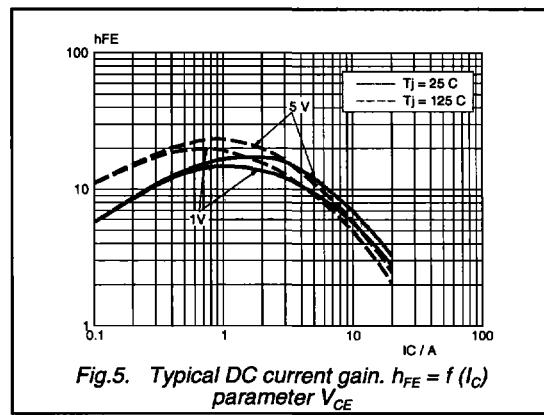
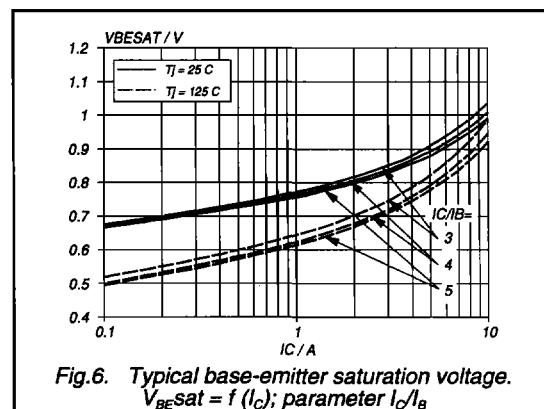
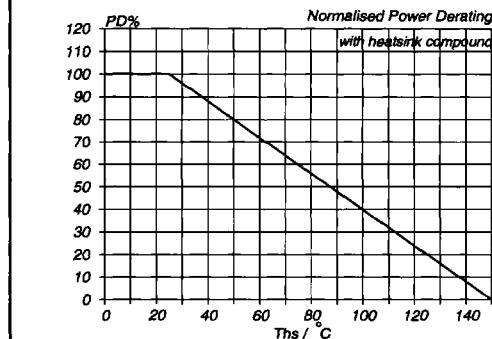
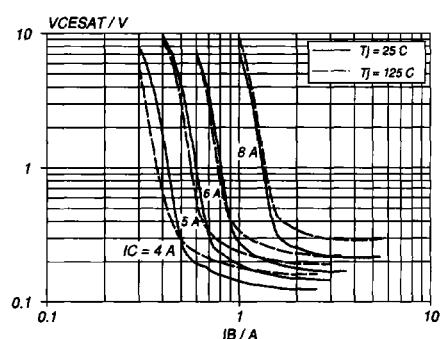
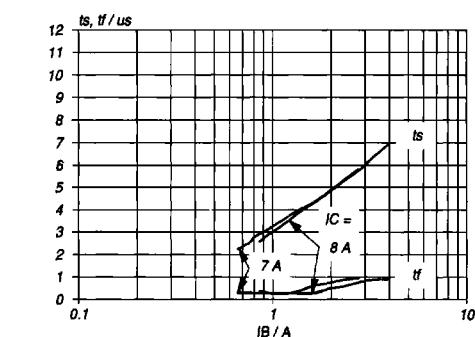
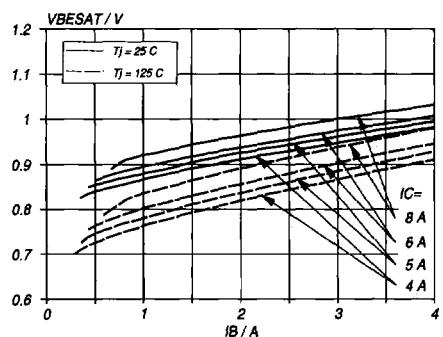
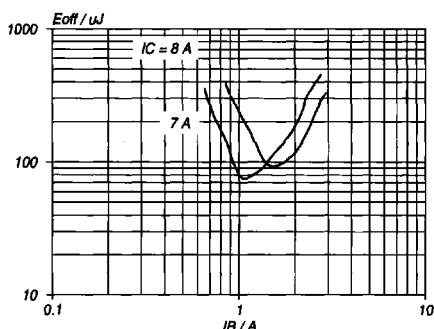
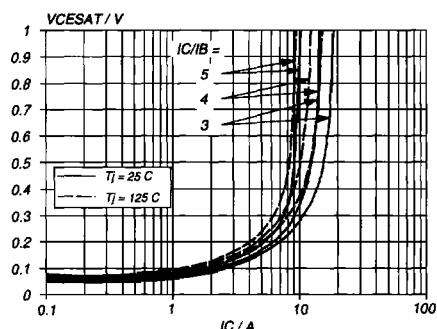


Fig. 2. Switching times definitions.

Fig. 3. Definition of anti-parallel diode V_{fr} and t_{fr} .

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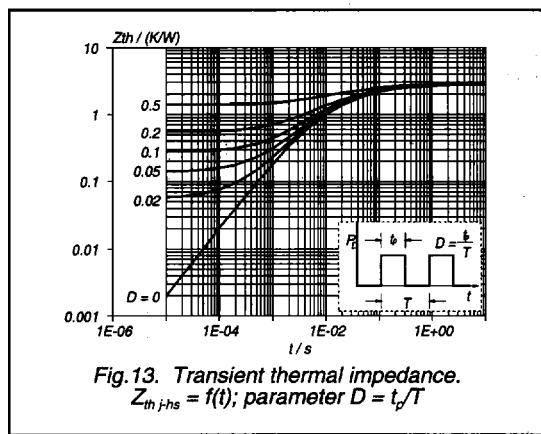


Fig.13. Transient thermal impedance.
 $Z_{th,hs} = f(t)$; parameter $D = t_p/T$

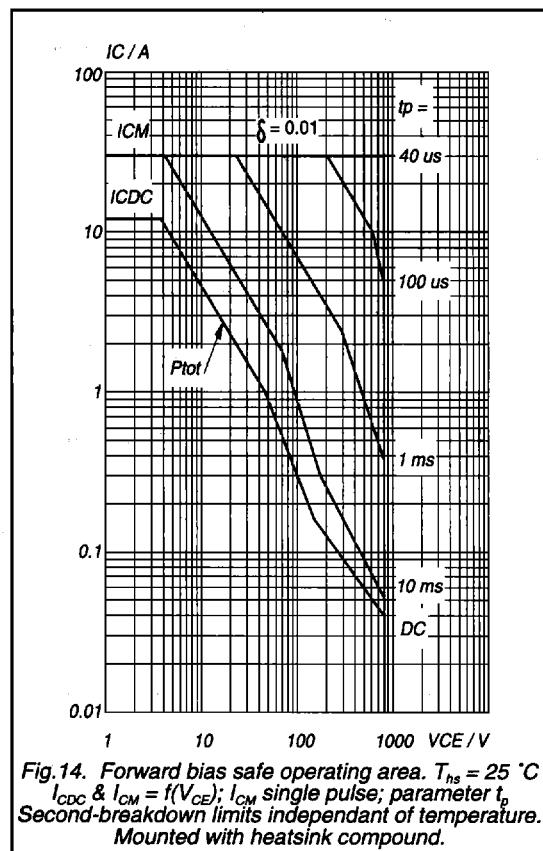


Fig.14. Forward bias safe operating area. $T_{hs} = 25^\circ C$
 I_{CDC} & $I_{CM} = f(V_{CE})$; I_{CM} single pulse; parameter t_p
Second-breakdown limits independant of temperature.
Mounted with heatsink compound.